

1998 Fairchild Semiconductor Corporation

THERMAL CHARACTERISTICS

R_{θJA}

 $\mathsf{R}_{_{\!\!\!\!\theta\!J\!C}}$

Thermal Resistance, Junction-to-Ambient

Thermal Resistance, Junction-to-Case

(Note 2)

(Note 2)

FDC6326L Rev.D1

°C/W

°C/W

180

60

Electrical Characteristics (T _A = 25°C unless otherwise noted)								
Symbol	Parameter	Conditions	Min	Тур	Max	Units		
OFF CHA	RACTERISTICS	·		•				
I _{FL}	Forward Leakage Current	$V_{IN} = 20 \text{ V}, V_{ON/OFF} = 0 \text{ V}$			1	μA		
ON CHAR	ACTERISTICS (Note 3)							
V _{DROP}	Conduction Voltage Drop	$V_{IN} = 12 \text{ V}, V_{ONOFF} = 3.3 \text{ V}, I_{L} = 1.5 \text{ A}$		0.15	0.2	V		
		$V_{IN} = 5 V, V_{ONOFF} = 3.3 V, I_{L} = 1 A$		0.14	0.2			
R _{DS(ON)}	Q2 - Static On-Resistance	$V_{GS} = -12 \text{ V}, \ I_{D} = -1.9 \text{ A}$		0.095	0.125	Ω		
		$V_{GS} = -5 \text{ V}, \text{ I}_{D} = -1.5 \text{ A}$		0.14	0.2			
I _L	Load Current	$V_{DROP} = 0.125 \text{ V}, V_{IN} = 12 \text{ V}, V_{ONOFF} = 3.3 \text{ V}$	1			А		
		$V_{DROP} = 0.20 V, V_{IN} = 5 V, V_{ON/OFF} = 3.3 V$	1					

Notes:

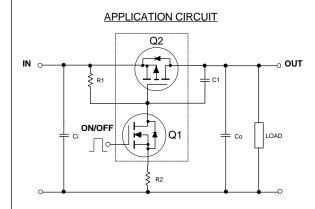
1. V_{IN} =20V, V_{ONOFF} =8V, T_{A} =25°C

2. R_{e.x} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface

of the drain pins. $R_{\mu Jc}$ is guaranteed by design while $R_{\mu CA}$ is determined by the user's board design.

3. Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2.0%.

FDC6326L Load Switch Application



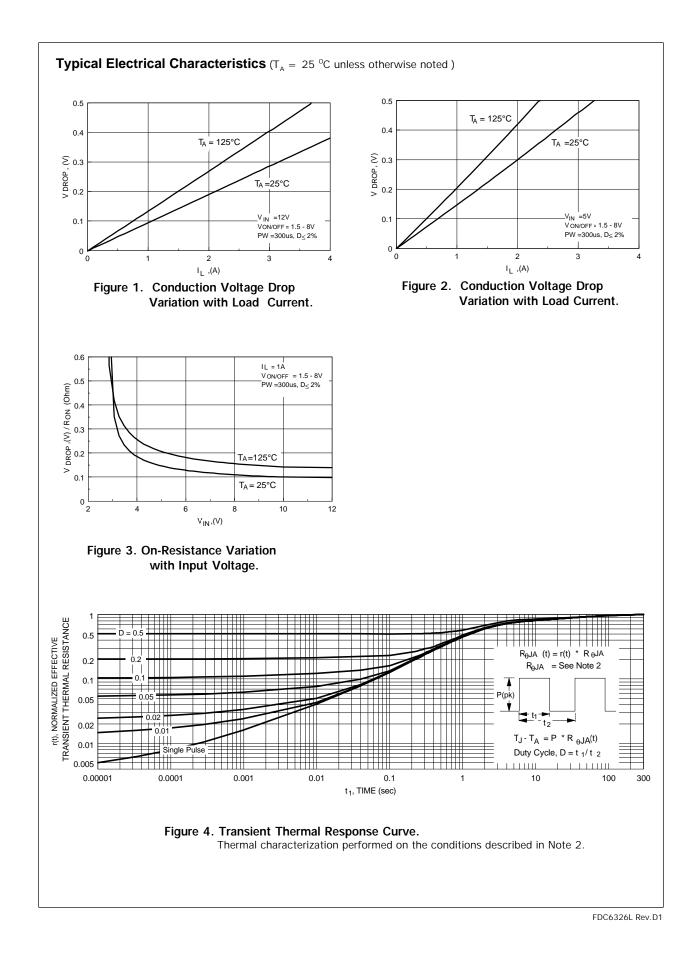
External Component Recommendation

First select R2, 100 - $1k\Omega$, for Slew Rate control.

 $C1 \le 1000 pF$ can be added in addition to R2 for further In-rush current control.

Then select R1 such that R1/R2 ratio maintains between 10 - 100. R1 is required to turn Q2 off.

For SPICE simulation, users can download a "FDC6326L.MOD" Spice model from Fairchild Web Site at www.fairchildsemi.com



TRADEMARKS

The following are registered and unregistered trademarks Fairchild Semiconductor owns or is authorized to use and is not intended to be an exhaustive list of all such trademarks.

ACExTM CoolFETTM CROSSVOLTTM E²CMOSTM FACTTM FACT Quiet SeriesTM FAST[®] FAST[®] FASTrTM GTOTM HiSeCTM ISOPLANAR[™] MICROWIRE[™] POP[™] PowerTrench[™] QFET[™] QS[™] Quiet Series[™] SuperSOT[™]-3 SuperSOT[™]-6 SuperSOT[™]-8 TinyLogic™ UHC™ VCX™

DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS.

LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION. As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, or (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in significant injury to the user. 2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

PRODUCT STATUS DEFINITIONS

Definition of Terms

Datasheet Identification	Product Status	Definition
Advance Information	Formative or In Design	This datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	This datasheet contains preliminary data, and supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
No Identification Needed	Full Production	This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
Obsolete	Not In Production	This datasheet contains specifications on a product that has been discontinued by Fairchild semiconductor. The datasheet is printed for reference information only.